

Excellent Integrated System Limited

Stocking Distributor

Click to view price, real time Inventory, Delivery & Lifecycle Information:

<u>Texas Instruments</u> <u>LMP7721MAX/NOPB</u>

For any questions, you can email us directly: sales@integrated-circuit.com



Datasheet of LMP7721MAX/NOPB - IC OPAMP GP 17MHZ RRO 8SOIC

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com













LMP7721

SNOSAW6E - JANUARY 2008 - REVISED DECEMBER 2014

LMP7721 3-Femtoampere Input Bias Current Precision Amplifier

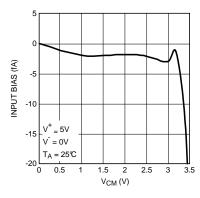
1 Features

- Unless Otherwise Noted, Typical Values at T_A = 25°C, V_S = 5 V.
- Input Bias Current (V_{CM} = 1 V)
 - Maximum at 25°C ±20 fA
 - Maximum at 85°C ±900 fA
- Offset Voltage ±26 μV
- Offset Voltage Drift −1.5 µV/°C
- DC Open-Loop Gain 120 dB
- DC CMRR 100 dB
- Input Voltage Noise (at f = 1 kHz) 6.5 nV/√Hz
- THD 0.0007%
- Supply Current 1.3 mA
- GBW 17 MHz
- Slew Rate (Falling Edge) 12.76 V/μs
- Supply Voltage 1.8 V to 5.5 V
- Operating Temperature Range -40°C to 125°C
- 8-Pin SOIC

2 Applications

- Photodiode Amplifier
- High Impedance Sensor Amplifier
- Ion Chamber Amplifier
- Electrometer Amplifier
- pH Electrode Amplifier
- Transimpedance Amplifier

Ultra-Low Input Bias Current



3 Description

The LMP7721 is the industry's lowest specified input bias current precision amplifier. The ultra-low input bias current is 3 fA, with a specified limit of ±20 fA at 25°C and ±900 fA at 85°C. This is achieved with the latest patent-pending technology of input bias current cancellation amplifier circuitry. This technology also maintains the ultra-low input bias current over the entire input common-mode voltage range of the amplifier.

Other outstanding features, such as low voltage noise (6.5 nV/√Hz), low DC-offset voltage (±150 μV maximum 25°C) and low-offset at temperature coefficient (-1.5 μV/°C), improve system sensitivity and accuracy in high-precision applications. With a supply voltage range of 1.8 V to 5.5 V, the LMP7721 is the ideal choice for batteryoperated, portable applications. The LMP7721 is part of the LMP™ precision amplifier family.

As part of Texas Instruments' PowerWise™ products, the LMP7721 provides the remarkably wide-gain bandwidth product (GBW) of 17 MHz while consuming only 1.3 mA of current. This wide GBW along with the high open-loop gain of 120 dB enables accurate signal conditioning. With these specifications, the LMP7721 has the performance to excel in a wide variety of applications such as electrochemical cell amplifiers and sensor interface circuits.

The LMP7721 is offered in an 8-pin SOIC package with a special pinout that isolates the amplifier's input from the power supply and output pins. With proper board layout techniques, the unique pinout of the LMP7721 will prevent PCB leakage current from reaching the input pins. Thus system error will be further reduced.

Device Information(1)

PART NUMBER	PACKAGE	BODY SIZE (NOM)
LMP7721	SOIC (8)	4.90 mm × 3.90 mm

(1) For all available packages, see the orderable addendum at the end of the datasheet.



Datasheet of LMP7721MAX/NOPB - IC OPAMP GP 17MHZ RRO 8SOIC

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



Information 26

12 Mechanical, Packaging, and Orderable

LMP7721

SNOSAW6E - JANUARY 2008-REVISED DECEMBER 2014

www.ti.com

1	Features 1	7.3 Feature Description
2	Applications 1	7.4 Device Functional Modes
3	Description 1	8 Application and Implementation 20
4	Revision History2	8.1 Application Information
5	Pin Configuration and Functions	8.2 Typical Application22
6	Specifications4	9 Power Supply Recommendations
Ū	6.1 Absolute Maximum Ratings	10 Layout
	6.2 ESD Ratings	10.1 Layout Guidelines25
	6.3 Recommended Operating Conditions	10.2 Layout Example25
	6.4 Thermal Information	11 Device and Documentation Support 26
	6.5 Electrical Characteristics: 2.5 V	11.1 Device Support
	6.6 Electrical Characteristics: 5 V	11.2 Documentation Support
	6.7 Typical Characteristics 8	11.3 Trademarks 26

Table of Contents

4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

С	hanges from Revision D (March 2013) to Revision E	Page
•	Added Pin Configuration and Functions section, ESD Ratings table, Feature Description section, Device Functional Modes, Application and Implementation section, Power Supply Recommendations section, Layout section, Device and Documentation Support section, and Mechanical, Packaging, and Orderable Information section	
С	hanges from Revision C (March 2013) to Revision D	Page
•	Changed layout of National Data Sheet to TI format	25

Product Folder Links: LMP7721

Submit Documentation Feedback

Copyright © 2008–2014, Texas Instruments Incorporated

Datasheet of LMP7721MAX/NOPB - IC OPAMP GP 17MHZ RRO 8SOIC

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

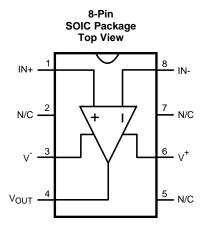


www.ti.com

LMP7721

SNOSAW6E -JANUARY 2008-REVISED DECEMBER 2014

5 Pin Configuration and Functions



Note: Non-standard single pinout. Substitutions may require a new layout.

Pin Functions

PIN		I/O	DECCRIPTION	
NAME	NO.	1/0	DESCRIPTION	
IN+	1	I	Non-Inverting Input	
N/C	2	-	lo Internal Connection (1)	
V-	3	Р	legative Power Supply	
VOUT	4	0	Output	
N/C	5	-	No Internal Connection	
V+	6	Р	Positive Power Supply	
N/C	7	-	No Internal Connection (1)	
IN-	8	ļ	Inverting Input	

Product Folder Links: LMP7721

(1) Recommeded to connect to system guard trace.

Copyright © 2008–2014, Texas Instruments Incorporated

Submit Documentation Feedback

3



Datasheet of LMP7721MAX/NOPB - IC OPAMP GP 17MHZ RRO 8SOIC

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



LMP7721

SNOSAW6E - JANUARY 2008 - REVISED DECEMBER 2014

www.ti.com

6 Specifications

6.1 Absolute Maximum Ratings⁽¹⁾⁽²⁾

		MIN	MAX	UNIT
V _{IN} Differential		-0.3	0.3	V
Supply Voltage $(V_S = V^+ - V^-)^{(3)}$		-0.3	6.0	V
Voltage on Input/Output Pins		V ⁺ + 0.3	V ⁻ - 0.3	V
Junction Temperature (4)			150	°C
Soldering Information	<u>.</u>			
Infrared or Convection (20 sec)			235	°C
Wave Soldering Lead Temp. (10 sec)			260	°C
Storage temperature, T _{stg}		-65	150	°C

- (1) Absolute Maximum Ratings⁽¹⁾⁽²⁾ indicate limits beyond which damage to the device may occur. Recommended Operating Conditions indicate conditions for which the device is intended to be functional, but specific performance is not ensured. For ensured specifications and the test conditions, see the Electrical Characteristics Tables.
- (2) If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/Distributors for availability and specifications.
- 3) The voltage on any pin should not exceed 6V relative to any other pins.
- (4) The maximum power dissipation is a function of T_{J(MAX)}, θ_{JA}. The maximum allowable power dissipation at any ambient temperature is P_D = (T_{J(MAX)} - T_A)/θ_{JA}. All numbers apply for packages soldered directly onto a PC Board.

6.2 ESD Ratings

				VALUE	UNIT
			Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 (1)	±2000	
٧	(ESD)	Electrostatic discharge	Charged-device model (CDM), per JEDEC specification JESD22-C101 ⁽²⁾	±200	V

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

6.3 Recommended Operating Conditions

<u></u>			
	MIN	MAX	UNIT
Temperature Range ⁽¹⁾	-40	125	°C
Supply Voltage $(V_S = V^+ - V^-)$:			
0°C ≤ T _A ≤ 125°C	1.8	5.5	V
-40°C ≤ T _A ≤ 125°C	2.0	5.5	V

⁽¹⁾ The maximum power dissipation is a function of $T_{J(MAX)}$, θ_{JA} . The maximum allowable power dissipation at any ambient temperature is $P_D = (T_{J(MAX)}, -T_A)/\theta_{JA}$. All numbers apply for packages soldered directly onto a PC Board.

6.4 Thermal Information

		LMP7721	
	THERMAL METRIC (1)	D	UNIT
		8 PINS	
R _{θJ}	Junction-to-ambient thermal resistance	190	°C/W

(1) For more information about traditional and new thermal metrics, see the IC Package Thermal Metrics application report, SPRA953.



Datasheet of LMP7721MAX/NOPB - IC OPAMP GP 17MHZ RRO 8SOIC

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



LMP7721

SNOSAW6E - JANUARY 2008 - REVISED DECEMBER 2014

www.ti.com

6.5 Electrical Characteristics: 2.5 V

Unless otherwise specified, all limits are specified for $T_A = 25$ °C, $V^+ = 2.5$ V, $V^- = 0$ V, $V_{CM} = (V^+ + V^-)/2$.

	PARAMETER	TEST CONDITION	ONS	MIN ⁽¹⁾	TYP ⁽²⁾	MAX ⁽¹⁾	UNIT	
Vos	Input Offset Voltage			-180	±50	180	\/	
		-40°C ≤ T _J ≤ 125°C		-480		480	μV	
TC V _{OS}	Input Offset Voltage Drift				-1.5	-4	μV/°C	
I _{BIAS}	Input Bias Current	$V_{CM} = 1 V^{(4)} (5)$ 2	25°C	-20	±3	20	40	
		-	-40°C to 85°C	-900		900	fA	
		-	-40°C to 125°C	- 5		5	pА	
I _{OS}	Input Offset Current	V _{CM} = 1 V ⁽⁵⁾			±6	±40	fA	
CMRR	Common-Mode Rejection Ratio	$0 \text{ V} \leq \text{V}_{\text{CM}} \leq 1.4 \text{ V}$		83	100		٩D	
		$0 \text{ V} \le \text{V}_{\text{CM}} \le 1.4 \text{ V}, -40^{\circ}\text{C} \le$	T _J ≤ 125°C	80			dB	
PSRR	Power Supply Rejection Ratio	$1.8 \text{ V} \le \text{V}^+ \le 5.5 \text{ V}, \text{ V}^- = 0 \text{ V}$	$V_{CM} = 0$	84	92			
		1.8 V \leq V ⁺ \leq 5.5 V, V ⁻ = 0 V -40°C \leq T _J \leq 125°C	$V_{CM} = 0,$	80			dB	
CMVR	Input Common-Mode Voltage	CMRR ≥ 80 dB		-0.3		1.5		
	Range	CMRR ≥ 78 dB, -40°C ≤ T _J	≤ 125°C	-0.3		1.5	V	
A _{VOL}	Large Signal Voltage Gain	$V_0 = 0.15 \text{ V to } 2.2 \text{ V}, R_L = 20 \text{ N}$	2 kΩ to V+/2	88	107			
		$V_O = 0.15 \text{ V to } 2.2 \text{ V}, R_L = 200$ -40°C \le T _J \le 125°C	2 kΩ to V+/2,	82				
		$V_0 = 0.15 \text{ V to } 2.2 \text{ V}, R_L = 1$	0 kΩ to V+/2	92	120		dB	
		$V_O = 0.15 \text{ V to } 2.2 \text{ V}, R_L = 1$ -40°C \le T _J \le 125°C	0 kΩ to V ⁺ /2,	88				
Vo	Output Swing High	$R_L = 2 k\Omega$ to $V^+/2$		70	25		mV from V ⁺	
		$R_L = 2 k\Omega$ to $V^+/2$, $-40^{\circ}C \le 1$	T _J ≤ 125°C	77				
		$R_L = 10 \text{ k}\Omega \text{ to V}^+/2$		60	20			
		$R_L = 10 \text{ k}\Omega \text{ to V}^+/2, -40^{\circ}\text{C} \le$	≤ T _J ≤ 125°C	66				
	Output Swing Low	$R_L = 2 k\Omega$ to $V^+/2$				70		
		$R_L = 2 k\Omega$ to $V^+/2$, $-40^{\circ}C \le 3$	T _J ≤ 125°C			73	ma\/	
		$R_L = 10 \text{ k}\Omega \text{ to V}^+/2$			15	60	mV	
		$R_L = 10 \text{ k}\Omega \text{ to V}^+/2, -40^{\circ}\text{C} \le$	≤ T _J ≤ 125°C			62		
Io	Output Short Circuit Current	Sourcing to V ⁻ , V _{IN} = 200 m	V ⁽⁶⁾	36	46			
		Sourcing to V ⁻ , $V_{IN} = 200 \text{ m}$ $T_J \le 125^{\circ}\text{C}$	V ⁽⁶⁾ , –40°C ≤	30			A	
		Sinking to V^+ , $V_{IN} = -200 \text{ m}$	V ⁽⁶⁾	7.5	15		mA	
		Sinking to V ⁺ , $V_{IN} = -200 \text{ m}$ $T_J \le 125^{\circ}\text{C}$	V ⁽⁶⁾ , −40°C ≤	5.0				
I _S	Supply Current				1.1	1.5	т Л	
		-40°C ≤ T _J ≤ 125°C				1.75	mA	
SR	Slew Rate	$A_V = +1$, Rising (10% to 90%)	%)		9.3		\//	
		$A_V = +1$, Falling (90% to 10°	%)		10.8		V/µs	
GBW	Gain Bandwidth Product				15		MHz	
e _n	Input-Referred Voltage Noise	f = 400 Hz			8		n\//\	
		f = 1 kHz			7		nV/√Hz	

⁽¹⁾ Limits are 100% production tested at 25°C. Limits over the operating temperature range are specified through correlations using the Statistical Quality Control (SQC) method.

Submit Documentation Feedback

⁽²⁾ Typical values represent the most likely parametric norm as determined at the time of characterization. Actual typical values may vary over time and will also depend on the application and configuration. The typical values are not tested and are not specified on shipped production material.

⁽³⁾ Offset voltage average drift is determined by dividing the change in V_{OS} at the temperature extremes by the total temperature change.

⁽⁴⁾ Positive current corresponds to current flowing into the device.

⁽⁵⁾ This parameter is specified by design and/or characterization and is not tested in production.

⁽⁶⁾ The short circuit test is a momentary open loop test.



Datasheet of LMP7721MAX/NOPB - IC OPAMP GP 17MHZ RRO 8SOIC

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



LMP7721

SNOSAW6E - JANUARY 2008 - REVISED DECEMBER 2014

www.ti.com

Electrical Characteristics: 2.5 V (continued)

Unless otherwise specified, all limits are specified for $T_A = 25^{\circ}C$, $V^+ = 2.5$ V, $V^- = 0$ V, $V_{CM} = (V^+ + V^-)/2$.

	PARAMETER	TEST CONDITIONS	MIN ⁽¹⁾	TYP ⁽²⁾	MAX ⁽¹⁾	UNIT
In	Input-Referred Current Noise	f = 1 kHz		0.01		pA/√Hz
THD+N	Total Harmonic Distortion + Noise	$f = 1 \text{ kHz}, A_V = 2, R_L = 100 \text{ k}Ω$ $V_O = 0.9 \text{ V}_{PP}$		0.003%		
		f = 1 kHz, A_V = 2, R_L = 600 $Ω$ V_O = 0.9 V_{PP}		0.003%		

6.6 Electrical Characteristics: 5 V

Unless otherwise specified, all limits are specified for $T_A = 25$ °C, $V^+ = 5$ V, $V^- = 0$ V, $V_{CM} = (V^+ + V^-)/2$.

	PARAMETER	TEST CO	NDITIONS	MIN ⁽¹⁾	TYP ⁽²⁾	MAX ⁽¹⁾	UNIT	
Vos	Input Offset Voltage			-150	±26	150	\/	
		-40°C ≤ T _J ≤ 125°C		450		450	μV	
TC V _{OS}	Input Offset Average Drift				-1.5	-4	μV/°C	
I _{BIAS}	Input Bias Current	V _{CM} = 1 V ^{(4) (5)}	25°C	-20	±3	20	fA	
			-40°C to 85°C	-900		900	IA	
			-40°C to 125°C	-5		5	рА	
Ios	Input Offset Current	(5)			±6	±40	fA	
CMRR	Common-Mode Rejection Ratio	$0 \text{ V} \le \text{V}_{\text{CM}} \le 3.7 \text{ V}$		84	100		٩D	
		$0 \text{ V} \le \text{V}_{\text{CM}} \le 3.7 \text{ V}, -$	40°C ≤ T _J ≤ 125°C	82			dB	
PSRR	Power Supply Rejection Ratio	$1.8 \text{ V} \le \text{V}^+ \le 5.5 \text{ V}, \text{ V}$	$V^{-} = 0 \text{ V}, \text{ V}_{CM} = 0$	84	96			
		1.8 V \leq V ⁺ \leq 5.5 V, V -40°C \leq T _J \leq 125°C	$V^{-} = 0 \text{ V}, \text{ V}_{CM} = 0,$	80		dB		
CMVR	Input Common-Mode Voltage	CMRR ≥ 80 dB		-0.3		4	4 4	
	Range	CMRR ≥ 78 dB, -40°	°C ≤ T _J ≤ 125°C	-0.3		4		
A _{VOL}	Large Signal Voltage Gain	$V_O = 0.3 \text{ V to } 4.7 \text{ V},$	$R_L = 2 k\Omega \text{ to } V^+/2$	88	111			
		$V_{O} = 0.3 \text{ V to } 4.7 \text{ V},$ -40°C \le T_{J} \le 125°C	$R_L = 2 k\Omega \text{ to } V^+/2,$	82			dB	
		$V_O = 0.3 \text{ V to } 4.7 \text{ V},$	$R_L = 10 \text{ k}\Omega \text{ to V}^+/2$	92	120			
		$V_{O} = 0.3 \text{ V to } 4.7 \text{ V},$ -40°C \le T _J \le 125°C	$R_L = 10 \text{ k}\Omega \text{ to V}^+/2,$	88				
Vo	Output Swing High	$R_L = 2 k\Omega \text{ to } V^+/2$		70	30			
		$R_L = 2 k\Omega \text{ to } V^+/2, -4$	40°C ≤ T _J ≤ 125°C	77			mV	
		$R_L = 10 \text{ k}\Omega \text{ to V}^+/2$		60	20		from V+	
		$R_L = 10 \text{ k}\Omega \text{ to } V^+/2,$	-40°C ≤ T _J ≤ 125°C	66				
	Output Swing Low	$R_L = 2 k\Omega \text{ to } V^+/2$			31	70	mV	
		$R_L = 2 k\Omega \text{ to } V^+/2, -4$	40°C ≤ T _J ≤ 125°C			73		
		$R_L = 10 \text{ k}\Omega \text{ to V}^+/2$			20	60		
		$R_L = 10 \text{ k}\Omega \text{ to } V^+/2, -$	-40°C ≤ T _J ≤ 125°C			62		

⁽¹⁾ Limits are 100% production tested at 25°C. Limits over the operating temperature range are specified through correlations using the Statistical Quality Control (SQC) method.

Typical values represent the most likely parametric norm as determined at the time of characterization. Actual typical values may vary over time and will also depend on the application and configuration. The typical values are not tested and are not specified on shipped production material. Offset voltage average drift is determined by dividing the change in V_{OS} at the temperature extremes by the total temperature change.

Positive current corresponds to current flowing into the device.

^{(&}lt;del>5) This parameter is specified by design and/or characterization and is not tested in production.

www.ti.com

Distributor of Texas Instruments: Excellent Integrated System Limited

Datasheet of LMP7721MAX/NOPB - IC OPAMP GP 17MHZ RRO 8SOIC

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



LMP7721

SNOSAW6E - JANUARY 2008-REVISED DECEMBER 2014

Electrical Characteristics: 5 V (continued)

Unless otherwise specified, all limits are specified for $T_A = 25$ °C, $V^+ = 5$ V, $V^- = 0$ V, $V_{CM} = (V^+ + V^-)/2$.

	PARAMETER	TEST CONDITIONS	MIN ⁽¹⁾	TYP ⁽²⁾	MAX ⁽¹⁾	UNIT
Io	Output Short Circuit Current	Sourcing to V ⁻ , V _{IN} = 200 mV ⁽⁶⁾	46	60		
		Sourcing to V ⁻ , V_{IN} = 200 mV ⁽⁶⁾ , -40°C \leq $T_J \leq$ 125°C	38			A
		Sinking to V ⁺ , $V_{IN} = -200 \text{ mV}^{(6)}$	10.5	22		mA
		Sinking to V ⁺ , $V_{IN} = -200 \text{ mV}^{(6)}$, $-40^{\circ}\text{C} \le T_J \le 125^{\circ}\text{C}$	6.5			
Is	Supply Current			1.3	1.7	A
		-40°C ≤ T _J ≤ 125°C			1.95	mA
SR	Slew Rate	A _V = +1, Rising (10% to 90%)		10.43		V/µs
		A _V = +1, Falling (90% to 10%)		12.76		
GBW	Gain Bandwidth Product			17		MHz
e _n	Input-Referred Voltage Noise	f = 400 Hz		7.5		nV/√Hz
		f = 1 kHz		6.5		NV/√HZ
In	Input-Referred Current Noise	f = 1 kHz		0.01		pA/√Hz
THD+N	Total Harmonic Distortion + Noise	$f = 1 \text{ kHz}, A_V = 2, R_L = 100 \text{ k}\Omega$ $V_O = 4 \text{ V}_{PP}$		0.0007%		
		$f = 1 \text{ kHz}, A_V = 2, R_L = 600\Omega$ $V_O = 4 V_{PP}$		0.0007%		

⁽⁶⁾ The short circuit test is a momentary open loop test.



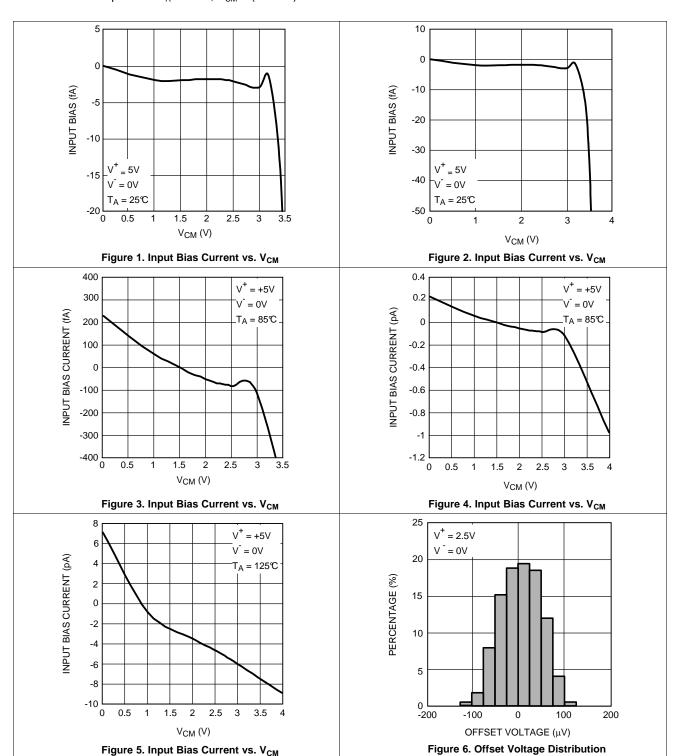
LMP7721

SNOSAW6E - JANUARY 2008 - REVISED DECEMBER 2014

www.ti.com

6.7 Typical Characteristics

Unless otherwise specified: $T_A = 25^{\circ}C$, $V_{CM} = (V^+ + V^-)/2$.



Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

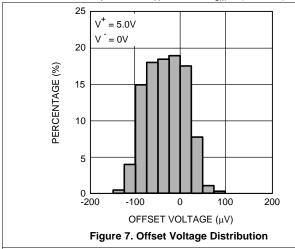
www.ti.com

LMP7721

SNOSAW6E - JANUARY 2008 - REVISED DECEMBER 2014

Typical Characteristics (continued)

Unless otherwise specified: $T_A = 25^{\circ}C$, $V_{CM} = (V^+ + V^-)/2$.



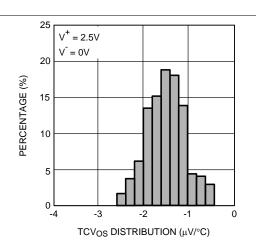


Figure 8. TCV_{OS} Distribution

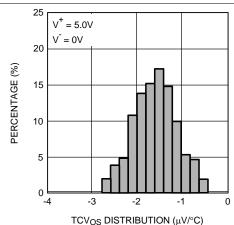


Figure 9. TCV_{OS} Distribution

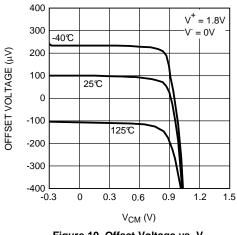


Figure 10. Offset Voltage vs. V_{CM}

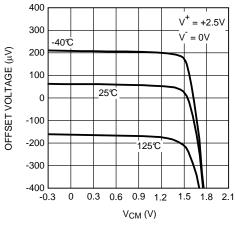


Figure 11. Offset Voltage vs. V_{CM}

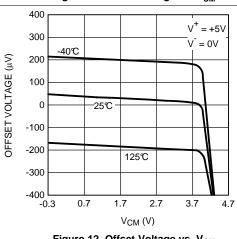


Figure 12. Offset Voltage vs. V_{CM}

Datasheet of LMP7721MAX/NOPB - IC OPAMP GP 17MHZ RRO 8SOIC

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



LMP7721

SNOSAW6E - JANUARY 2008 - REVISED DECEMBER 2014

www.ti.com

Typical Characteristics (continued)

Unless otherwise specified: $T_A = 25^{\circ}C$, $V_{CM} = (V^+ + V^-)/2$.

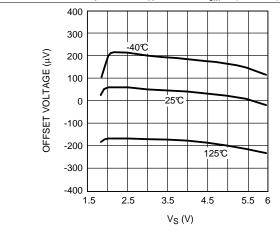


Figure 13. Offset Voltage vs. Supply Voltage

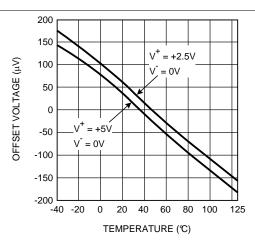


Figure 14. Offset Voltage vs. Temperature

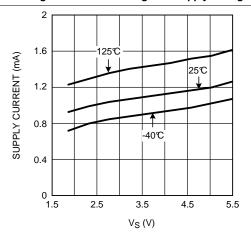


Figure 15. Supply Current vs. Supply Voltage

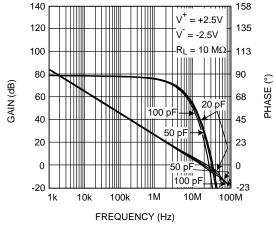


Figure 16. Open-Loop Frequency Response Gain and Phase

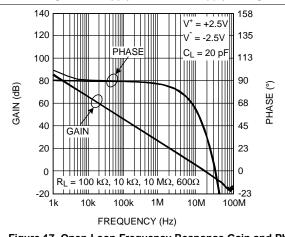


Figure 17. Open-Loop Frequency Response Gain and Phase

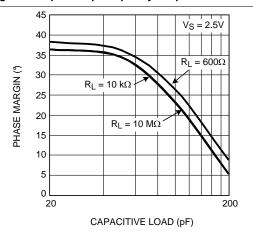


Figure 18. Phase Margin vs. Capacitive Load

Submit Documentation Feedback

Copyright © 2008–2014, Texas Instruments Incorporated

www.ti.com



Texas **INSTRUMENTS**

LMP7721

SNOSAW6E - JANUARY 2008 - REVISED DECEMBER 2014

Typical Characteristics (continued)

Unless otherwise specified: $T_A = 25$ °C, $V_{CM} = (V^+ + V^-)/2$.

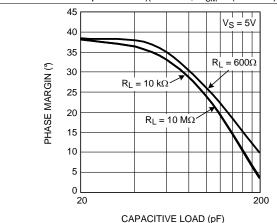


Figure 19. Phase Margin vs. Capacitive Load

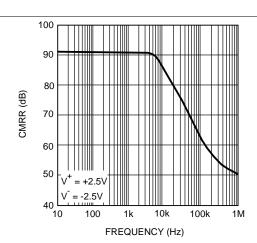


Figure 20. CMRR vs. Frequency

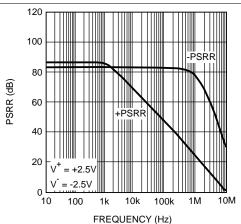


Figure 21. PSRR vs. Frequency

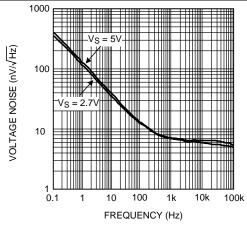


Figure 22. Input-Referred Voltage Noise vs. Frequency

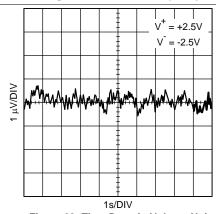


Figure 23. Time Domain Voltage Noise

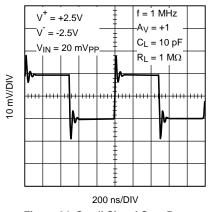


Figure 24. Small Signal Step Response

Datasheet of LMP7721MAX/NOPB - IC OPAMP GP 17MHZ RRO 8SOIC

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



LMP7721

SNOSAW6E - JANUARY 2008 - REVISED DECEMBER 2014

www.ti.com

Typical Characteristics (continued)

Unless otherwise specified: $T_A = 25^{\circ}C$, $V_{CM} = (V^+ + V^-)/2$.

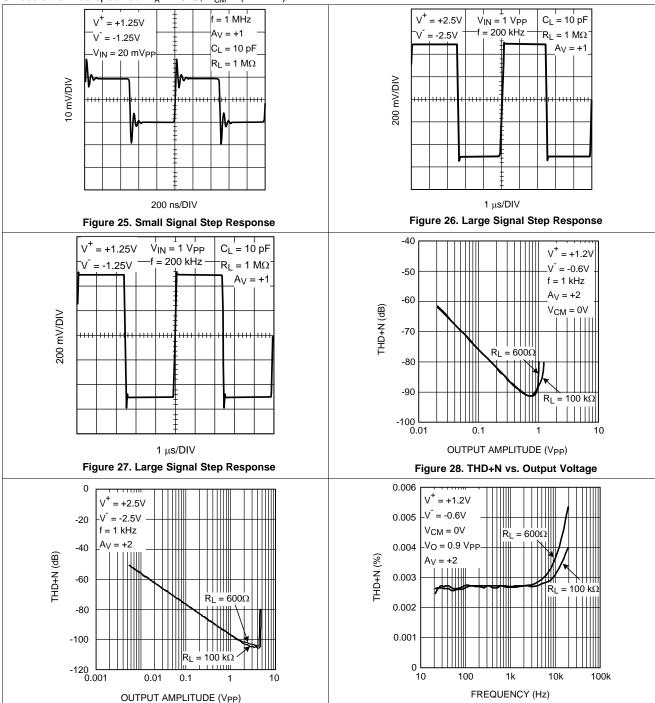


Figure 29. THD+N vs. Output Voltage

Figure 30. THD+N vs. Frequency

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

LMP7721

SNOSAW6E - JANUARY 2008 - REVISED DECEMBER 2014

www.ti.com

Typical Characteristics (continued)

Unless otherwise specified: $T_A = 25$ °C, $V_{CM} = (V^+ + V^-)/2$.

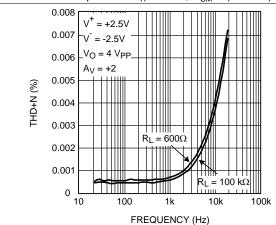


Figure 31. THD+N vs. Frequency

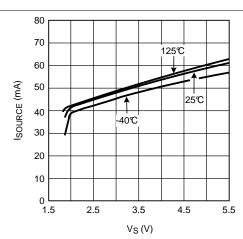


Figure 32. Sourcing Current vs. Supply Voltage

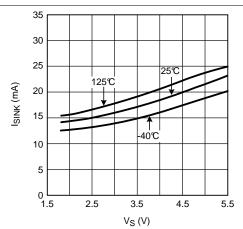


Figure 33. Sinking Current vs. Supply Voltage

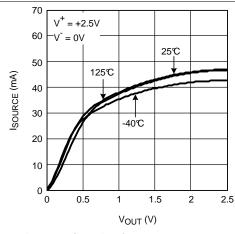


Figure 34. Sourcing Current vs. Output Voltage

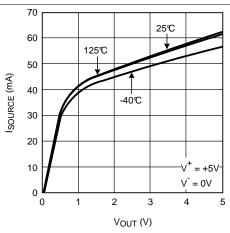


Figure 35. Sourcing Current vs. Output Voltage

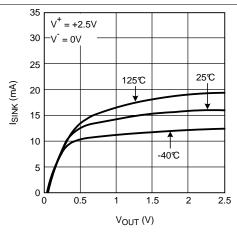


Figure 36. Sinking Current vs. Output Voltage



LMP7721

SNOSAW6E - JANUARY 2008-REVISED DECEMBER 2014

www.ti.com

Typical Characteristics (continued)

Unless otherwise specified: $T_A = 25$ °C, $V_{CM} = (V^+ + V^-)/2$.

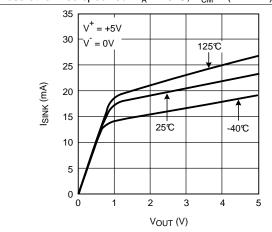


Figure 37. Sinking Current vs. Output Voltage

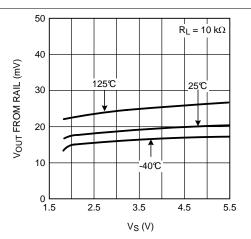


Figure 38. Output Swing High vs. Supply Voltage

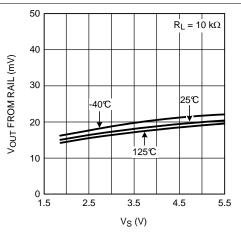


Figure 39. Output Swing Low vs. Supply Voltage

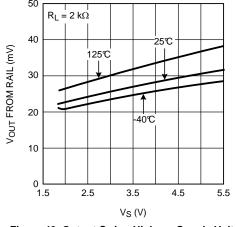
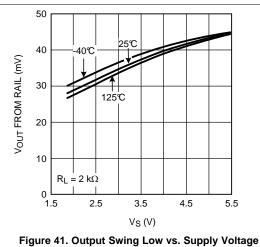


Figure 40. Output Swing High vs. Supply Voltage





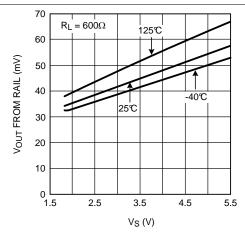


Figure 42. Output Swing High vs. Supply Voltage

Datasheet of LMP7721MAX/NOPB - IC OPAMP GP 17MHZ RRO 8SOIC

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



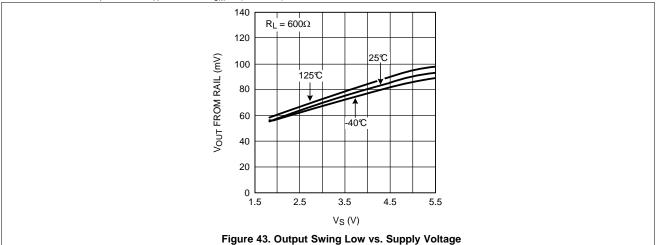
LMP7721

www.ti.com

SNOSAW6E - JANUARY 2008-REVISED DECEMBER 2014

Typical Characteristics (continued)

Unless otherwise specified: $T_A = 25$ °C, $V_{CM} = (V^+ + V^-)/2$.





Datasheet of LMP7721MAX/NOPB - IC OPAMP GP 17MHZ RRO 8SOIC

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



LMP7721

SNOSAW6E - JANUARY 2008 - REVISED DECEMBER 2014

www.ti.com

7 Detailed Description

7.1 Overview

The LMP7721 combines a patented input bias current cancelling circuitry along with an optimized pinout to provide and ultra-low maximum specified bias current of ±20 fA.

7.2 Functional Block Diagram

7.3 Feature Description

7.3.1 Ultra-Low Input Bias Current

The LMP7721 has the industry's lowest specified input bias current. The ultra-low input bias current is typically 3 fA, with a specified limit of ± 20 fA at 25°C, ± 900 fA at 85°C and ± 5 pA at 125°C when $V_{CM} = 1$ V with a 5-V or a 2.5-V power supply.

7.3.2 Wide Bandwidth at Low-Supply Current

The LMP7721 is a high-performance amplifier that provides a 17-MHz unity gain bandwidth while drawing only 1.3 mA of current. This makes the LMP7721 ideal for wideband amplification in portable applications.

7.3.3 Low Input Referred Noise

The LMP7721 has a low input-referred voltage noise density (6.5 nV/Hz at 1 kHz with 5-V supply). Its MOS input stage ensures a very low input-referred current noise density (0.01 pA//Hz).

The low input-referred noise and the ultra-low input bias current make the LMP7721 stand out in maintaining signal fidelity. This quality makes the LMP7721 a suitable candidate for sensor-based applications.

7.3.4 Low-Supply Voltage

The LMP7721 has performance specified at 2.5-V and 5-V power supplies. The LMP7721 is ensured to be functional at all supply voltages between 2 V to 5.5 V, for ambient temperatures ranging from -40°C to 125°C. This means that the LMP7721 has a long operational span over the battery's lifetime. The LMP7721 is also specified to be functional at 1.8-V supply voltage, for ambient temperatures ranging from 0°C to 125°C. This makes the LMP7721 ideal for use in low-voltage commercial applications.

7.3.5 Rail-to-Rail Output and Ground Sensing

Rail-to-rail output swing provides the maximum possible output dynamic range. This is particularly important when operating at low-supply voltages. An innovative positive feedback scheme is created to boost the LMP7721's output current drive capability. This allows the LMP7721 to source 30 mA to 40 mA of current at 1.8-V power supply.

The LMP7721's input common-mode range includes the negative supply rail which makes direct sensing at ground possible in single-supply operation.

Product Folder Links: LMP7721

Submit Documentation Feedback

Copyright © 2008-2014, Texas Instruments Incorporated

16

Datasheet of LMP7721MAX/NOPB - IC OPAMP GP 17MHZ RRO 8SOIC

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



LMP7721

www.ti.com

SNOSAW6E - JANUARY 2008 - REVISED DECEMBER 2014

Feature Description (continued)

7.3.6 Unique Pinout

The LMP7721 has been designed with the IN+ and IN-, V^+ and V^- pins on opposite sides of the package. There are isolation pins between IN+ and V^- , IN- and V+. This unique pinout makes it easy to guard the LMP7721's input. This pinout design reduces the input bias current's dependence on common mode or supply bias.

The SOIC package features low leakage and it has large pin spacing. This lowers the probability of dust particles settling down between two pins thus reducing the resistance between the pins which can be a problem.

The two No Connect (N/C) isolation pins are not internally connected and may be tied to the guard trace to provide down-into-the-package level guarding of the inputs.

7.3.7 Input Protection

The LMP7721 input stage is protected from seeing excessive differential input voltage by a pair of back-to-back diodes attached between the inputs. This limits the differential voltage and hence prevents phase inversion as well as any performance drift. These diodes can conduct current when the input signal has a really fast edge, and, if necessary, should be isolated (using a resistor or a current follower) in such cases. Under normal feedback operation, the average differential voltage is less than 1 mV and these diodes do not affect the normal operation of the device. This clamp also limits the use as a comparator, which is not a recommended function for operational amplifiers.

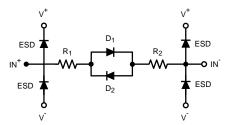


Figure 44. Input Protection Diodes

7.4 Device Functional Modes

7.4.1 Compensating Input Capacitance

The high-input resistance of the LMP7721 allows the use of large feedback and source resistor values without losing gain accuracy due to loading. However, the circuit will be especially sensitive to its layout when these large-value resistors are used.

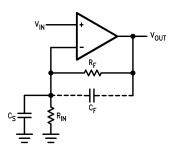


Figure 45. General Operational Amplifier Circuit

Every amplifier has some capacitance between each input and AC ground, and also some differential capacitance between the inputs. When the feedback network around an amplifier is resistive, this input capacitance (along with any additional capacitance due to circuit board traces, the socket, etc.) and the feedback resistors create a pole in the feedback path. This pole can cause gain "peaking" or outright oscillations.

Datasheet of LMP7721MAX/NOPB - IC OPAMP GP 17MHZ RRO 8SOIC

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



LMP7721

SNOSAW6E - JANUARY 2008-REVISED DECEMBER 2014

www.ti.com

Device Functional Modes (continued)

In the General Operational Amplifier circuit, Figure 45 the frequency of this pole is:

$$f_p = \frac{1}{2\pi C_S R_p} \tag{1}$$

where:

- C_S is the total capacitance at the inverting input, including amplifier input capacitance and any stray capacitance from the circuit board traces.
- R_P is the parallel combination of R_F and R_{IN}

The typical input capacitance of the LMP7721 is about 11pF. This formula, as well as all formulas derived below, apply to inverting and non-inverting op amp configurations.

When the feedback resistors are smaller than a few $k\Omega$, the frequency of the feedback pole will be quite high, since C_S is generally less than 15 pF. If the frequency of the feedback pole is much higher than the "ideal" closed-loop bandwidth (the nominal closed-loop bandwidth in the absence of C_S), the pole will have a negligible effect on stability, as it will add only a small amount of phase shift.

However, if the feedback pole is less than approximately 6 to 10 times the "ideal" -3 dB frequency, a feedback capacitor, C_F , should be connected between the output and the inverting input of the op amp. This condition can also be stated in terms of the amplifier's low-frequency noise gain: To maintain stability a feedback capacitor will probably be needed if

$$\left(\begin{array}{cc} \frac{\mathsf{R}_{\mathsf{F}}}{\mathsf{R}_{\mathsf{IN}}} + 1 \end{array}\right) \leq \sqrt{6 \times 2\pi \times \mathsf{GBW} \times \mathsf{R}_{\mathsf{F}} \times \mathsf{C}_{\mathsf{S}}} \tag{2}$$

where

$$\left(\begin{array}{cc} R_{\mathsf{F}} & + & 1 \end{array}\right) \tag{3}$$

is the amplifier's low-frequency noise gain and GBW is the amplifier's gain bandwidth product. An amplifier's low-frequency noise gain is represented by the formula

$$\left(\begin{array}{cc} \frac{\mathsf{R}_{\mathsf{F}}}{\mathsf{R}_{\mathsf{IN}}} + 1 \end{array}\right) \tag{4}$$

regardless of whether the amplifier is being used in inverting or noninverting mode. Note that a feedback capacitor is more likely to be needed when the noise gain is low and/or the feedback resistor is large.

If the above condition is met (indicating a feedback capacitor will probably be needed), and the noise gain is large enough that:

$$\left(\begin{array}{cc} \frac{\mathsf{R}_{\mathsf{F}}}{\mathsf{R}_{\mathsf{IN}}} + 1 \end{array}\right) \geq 2\sqrt{\mathsf{GBW} \times \mathsf{R}_{\mathsf{F}} \times \mathsf{C}_{\mathsf{S}}} \tag{5}$$

the following value of feedback capacitor is recommended:

$$C_{F} = \frac{C_{S}}{2\left(\frac{R_{F}}{R_{IN}} + 1\right)}$$
(6)

lf



Datasheet of LMP7721MAX/NOPB - IC OPAMP GP 17MHZ RRO 8SOIC

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



LMP7721

www.ti.com SNOSAW6E – JANUARY 2008–REVISED DECEMBER 2014

Device Functional Modes (continued)

$$\left(\begin{array}{cc} \frac{\mathsf{R}_{\mathsf{F}}}{\mathsf{R}_{\mathsf{IN}}} + 1 \end{array}\right) < 2\sqrt{\mathsf{GBW} \times \mathsf{R}_{\mathsf{F}} \times \mathsf{C}_{\mathsf{S}}} \tag{7}$$

the feedback capacitor should be:

$$C_F = \sqrt{\frac{C_S}{GBW \times R_F}}$$
 (8)

Note that these capacitor values are usually significant smaller than those given by the older, more conservative formula:

$$C_{F} = \frac{C_{S}R_{IN}}{R_{F}}$$
(9)

NOTE

 C_S consists of the amplifier's input capacitance plus any stray capacitance from the circuit board. C_F compensates for the pole caused by C_S and the feedback resistors.

Using the smaller capacitors will give much higher bandwidth with little degradation of transient response. It may be necessary in any of the above cases to use a somewhat larger feedback capacitor to allow for unexpected stray capacitance, or to tolerate additional phase shifts in the loop, or excessive capacitive load, or to decrease the noise or bandwidth, or simply because the particular circuit implementation needs more feedback capacitance to be sufficiently stable. For example, a printed circuit board's stray capacitance may be larger or smaller than the breadboard's, so the actual optimum value for C_F may be different from the one estimated using the breadboard. In most cases, the values of C_F should be checked on the actual circuit, starting with the computed value.

Product Folder Links: LMP7721

Copyright © 2008–2014, Texas Instruments Incorporated

Submit Documentation Feedback

19

Datasheet of LMP7721MAX/NOPB - IC OPAMP GP 17MHZ RRO 8SOIC

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



LMP7721

SNOSAW6E - JANUARY 2008 - REVISED DECEMBER 2014

www.ti.com

8 Application and Implementation

NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

8.1 Application Information

The LMP7721 is specified for operation from 1.8 V to 5.5 V. Many of the specifications apply from –40°C to 125°C. Parameters that can exhibit significant variance with regard to operating voltage or temperature are presented in the *Typical Characteristics* section.

8.1.1 Using a Guard

In order to take full advantage of the LMP7721's ultra-low input bias current, a "Guard" trace is recommended when designing sub-nanoamp systems.

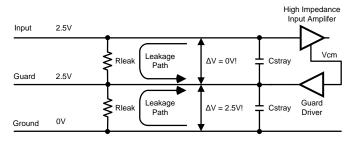


Figure 46. Guarding Theory

A "Guard" is a driven trace or shield that physically surrounds the input trace and feedback circuitry that is held at a potential equal to the average input signal potential. Since the input circuitry and the guard are kept at the same potential, the leakage current between the two nodes is practically zero. The guard is a low-impedance node, so any external leakages will "leak" into the guard and not into the protected input. One benefit of using a guard is it cancels the effect of the added stray and cable capacitance at low frequencies (but cannot cancel the sensor or amplifier input capacitance).

The guard potential may be taken from the inverting input (summing node) in noninverting and buffer applications. An example of this is shown in Figure 47 If the guarding needs to extend beyond the immediate local area around the IC, then a buffer should be used to drive the guard to prevent adding additional capacitance to the inverting node.

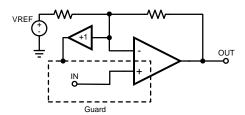


Figure 47. Guarding the Noninverting Configuration

The guard potential may be taken from the noninverting input or reference voltage in inverting or transimpedance applications. An example of this is shown in Figure 48

Datasheet of LMP7721MAX/NOPB - IC OPAMP GP 17MHZ RRO 8SOIC

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



www.ti.com

LMP7721

SNOSAW6E - JANUARY 2008-REVISED DECEMBER 2014

Application Information (continued)

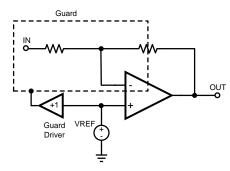


Figure 48. Guarding the Inverting or Transimpedance Configuration

The gain of the buffer should be slightly less than one to prevent oscillations and should be current limited to protect against short circuits. The buffer amplifier should also be capable of driving large capacitive loads. To satisfy these two requirements, a small series output resistor is usually placed on the buffer output in the range of 100 Ω to 1 k Ω .

For optimum results, the guard should completely enclose the input circuitry within a conductive "cocoon", including above and below the circuitry. A cover or shield connected to the guard should protect the circuitry above (or below) the PC board. Do not forget about thru-hole devices (like leaded photodiodes or connectors) that may expose high-impedance nodes to the opposite side of the board.

The guard trace should not be relied upon as the only method of shielding. A ground plane or shield should surround and protect the guard from large external leakages and noise, as the guard trace has the potential to couple noise back into the input. For more information on guarding, please see the articles referenced in *Related Documentation*.

8.1.2 Use Triaxial Cable

A triaxial cable or connector is similar to a coaxial cable or connector and is often referred to as "triax". The triaxial cable extends the guard protection through the length of the cable by adding a second internal guard "shield" around the center conductor in addition to the outer ground shield. Figure 49 shows the structure of the triax connector.

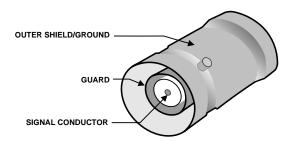


Figure 49. The Structure of a Triax

8.1.3 Properly Clean the Assembly

Proper cleaning of the board is very critical to providing the expected sub-picoamp performance. Properly cleaning the board and components takes a few extra steps over conventional board cleaning methods. Leftover flux residue, moisture and cleaning solvent residues will severely degrade the low-current performance.

Datasheet of LMP7721MAX/NOPB - IC OPAMP GP 17MHZ RRO 8SOIC

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



LMP7721

SNOSAW6E - JANUARY 2008 - REVISED DECEMBER 2014

www.ti.com

Application Information (continued)

If using "water soluble" or "no clean" flux, a second cleaning step is needed. These fluxes still leave a film behind that can attract contaminates and dust. The board should be washed with fresh isopropyl alcohol or methanol and baked to make sure all remaining traces of moisture are removed from the board. Areas between the component leads should be scrubbed and areas under surface mount devices thoroughly flushed. The board should be re-cleaned after any rework to components within the guarded areas. Boards should be handled by the edges and stored in sealed containers with desiccant.

8.2 Typical Application

The following application examples highlight only a few of the circuits where the LMP7721 can be used.

A CMOS input stage with ultra-low input bias current, negligible input current noise, and low input voltage noise allows the LMP7721 to provide high fidelity amplification. In addition, the LMP7721 has a 17 MHz gain bandwidth product, which enables high gain at wide bandwidth. A rail-to-rail output swing at 5.5-V power supply allows detection and amplification of a wide range of input currents. These properties make the LMP7721 ideal for transimpedance amplification.

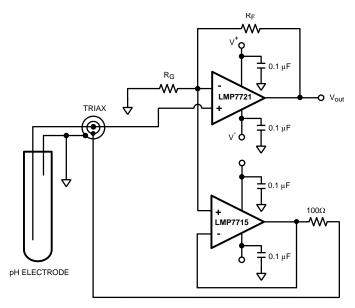


Figure 50. LMP7721 as pH Electrode Amplifier

8.2.1 Design Requirements

The output of a pH electrode is typically 59.16 mV per pH unit at 25°C, for an output range of 414 mV to -414 mV as the pH changes from 0 to 14 at 25°C.

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

www.ti.com

LMP7721

SNOSAW6E - JANUARY 2008-REVISED DECEMBER 2014

Typical Application (continued)

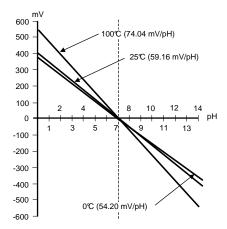


Figure 51. pH Electrode Transfer Function

The output impedance of a pH electrode is extremely high, ranging from 10 M Ω to 1000 M Ω . The ultra low input bias current of the LMP7721 allows the voltage error produced by the input bias current and electrode resistance to be minimal. For example, the output impedance of the pH electrode used is 10 M Ω , if an op amp with 3 nA of I_{bias} is used, the error caused due to this amplifier's input bias current and the source resistance of the pH electrode is 30 mV! This error can be greatly reduced to 30 nV by using the LMP7721.

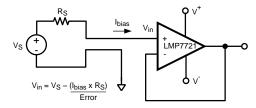


Figure 52. Error Caused by Amplifier's Input Bias Current and Sensor Source Impedance

8.2.2 Detailed Design Procedure

The output voltage of the pH electrode will range from 54.2 mV/pH at 0°C, to 74.04 mV/pH at 100°C. The maximum input voltage will then be ±74.04 mV * 7 = ±518.3 mV. Allowing for output swing and offset headroom, the maximum output swing should be limited to ±2.4V. The amplifier gain would then be 2.4 V / 0.5183 V = 4.6

With $R_F = 3.57 \text{ k}\Omega$ and $R_G = 1 \text{ k}\Omega$, the gain would be 4.57 V/V.

The output voltage from the pH electrode is fed to the signal conductor of the triax and then sent to the noninverting input of the LMP7721. In this application, the inverting input is a low impedance node and hence is used to drive the LMP7715 which acts as a guard driver. The output of the guard driver is connected to the guard of the triax through a $100-\Omega$ isolation resistor.

Figure 50 is an example of the LMP7721 used as a pH sensor amplifier.

Copyright © 2008–2014, Texas Instruments Incorporated

Submit Documentation Feedback

Datasheet of LMP7721MAX/NOPB - IC OPAMP GP 17MHZ RRO 8SOIC

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



LMP7721

SNOSAW6E - JANUARY 2008 - REVISED DECEMBER 2014

www.ti.com

Typical Application (continued)

8.2.3 Application Curve

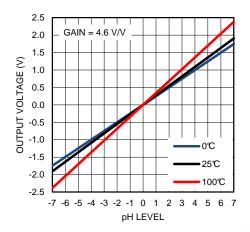


Figure 53. Output Voltage vs. pH Level

Product Folder Links: LMP7721

Submit Documentation Feedback

Copyright © 2008–2014, Texas Instruments Incorporated

24

Datasheet of LMP7721MAX/NOPB - IC OPAMP GP 17MHZ RRO 8SOIC

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



LMP7721

SNOSAW6E - JANUARY 2008-REVISED DECEMBER 2014

www.ti.com

9 Power Supply Recommendations

For high-sensitivity applications, the power supply rails should be as clean as possible.

Noise on the power supply lines can modulate the tiny capacitance (about 0.5 pF) of the ESD structure on each input. While this is not a major concern for most applications, charge-sensitive or high-gain, high-impedance applications can be affected. Common results are power line "hum" or high-frequency switcher "hash" imposed on the signal.

TI recommends using a very low noise linear regulator and add a dedicated filter network to the LMP7721 power supply pins consisting of a series resistor of about 100 Ω , and a bypass capacitor of 100 uF or larger. Series inductors or ferrite beads may be required if high frequency switcher noise is present.

10 Layout

10.1 Layout Guidelines

In order to capitalize on the LMP7721's ultra-low input bias current, careful circuit layout and assembly are required. Guarding techniques are highly recommended to reduce parasitic leakage current by isolating the LMP7721's input from large voltage gradients across the PC board. A guard is a low-impedance conductor that surrounds an input line and its potential is raised to the input line's voltage. The input pins should be fully guarded as shown in Figure 54. The guard traces should completely encircle the input connections. In addition, they should be located on both sides of the PCB and be connected together.

To further guard the inputs from the supply pins, the two N/C pins may be connected to the guard trace which will provide guarding down to the leadframe level.

Solder mask should not cover the input and the guard area including guard traces on either side of the PCB.

Keep switching power supplies and other noise-producing devices away from the input area.

10.2 Layout Example

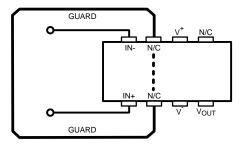


Figure 54. Layout Example Showing Guard Trace



Datasheet of LMP7721MAX/NOPB - IC OPAMP GP 17MHZ RRO 8SOIC

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



LMP7721

SNOSAW6E - JANUARY 2008-REVISED DECEMBER 2014

www.ti.com

11 Device and Documentation Support

11.1 Device Support

11.1.1 Development Support

- LMP7721 PSPICE Model, SNOM096
- TINA-TI SPICE Based Circuit Simulation Software (free download), http://www.ti.com/tool/tina-ti
- TI FilterPro Filter Design software, http://www.ti.com/tool/filterpro

11.2 Documentation Support

11.2.1 Related Documentation

For related documentation, see the following:

- LMP7721 Multi-Function Evaluation Board (current evaluation board), SNOU004
- AN-1796 LMP7721 Evaluation Board (obsolete evaluation board for reference only), SNOA513
- AN-1798 Designing with Electro-Chemical Sensors, SNOA514
- AN-1803 Design Considerations for a Transimpedance Amplifier, SNOA515
- AN-1852 Designing With pH Electrodes, SNOA529
- Compensate Transimpedance Amplifiers Intuitively, SBOA055
- Transimpedance Considerations for High-Speed Operational Amplifiers, SBOA112
- Noise Analysis of FET Transimpedance Amplifiers, SBOA060
- Circuit Board Layout Techniques SLOA089
- Handbook of Operational Amplifier Applications SBOA092
- Low Level Measurements Handbook, Keithley Instruments, Inc., Latest Edition. Available: www.keithley.com
- Grohe, P., "Design femtoampere circuits with low leakage, Part 1", EDN Magazine, November 7, 2011.
 Available: www.edn.com
- Grohe, P., "Design femtoampere circuits with low leakage, Part 2", EDN Magazine, June 15, 2012. Available: www.edn.com
- Grohe, P., "Design femtoampere circuits with low leakage, Part 3", EDN Magazine, September 7, 2012.
 Available: www.edn.com

11.3 Trademarks

LMP, PowerWise are trademarks of Texas Instruments.
All other trademarks are the property of their respective owners.

11.4 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

11.5 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

12 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.



Datasheet of LMP7721MAX/NOPB - IC OPAMP GP 17MHZ RRO 8SOIC

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

PACKAGE OPTION ADDENDUM

21-Oct-2014

PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package	Pins	Package	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	(6)	(3)		(4/5)	
LMP7721MA/NOPB	ACTIVE	SOIC	D	8	95	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LMP77 21MA	Samples
LMP7721MAX/NOPB	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	LMP77 21MA	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design. PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): Tl's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between

the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "-" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

Addendum-Page 1



Datasheet of LMP7721MAX/NOPB - IC OPAMP GP 17MHZ RRO 8SOIC Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

PACKAGE OPTION ADDENDUM

www.ti.com 21-Oct-2014

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

Addendum-Page 2

Datasheet of LMP7721MAX/NOPB - IC OPAMP GP 17MHZ RRO 8SOIC

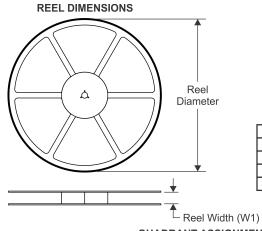
Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

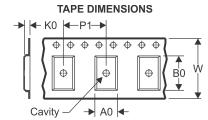


PACKAGE MATERIALS INFORMATION

21-Oct-2014 www.ti.com

TAPE AND REEL INFORMATION

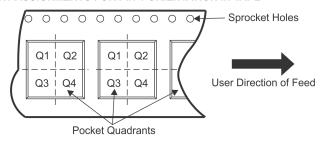




	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
	Ditab between accessing and the sentens

P1 Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

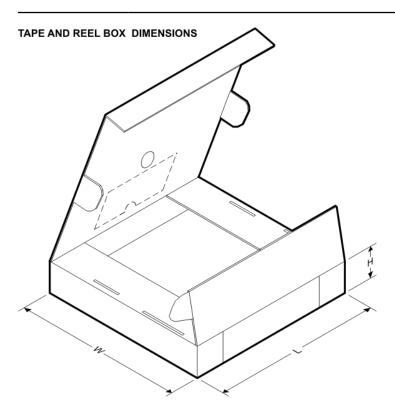
Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LMP7721MAX/NOPB	SOIC	D	8	2500	330.0	12.4	6.5	5.4	2.0	8.0	12.0	Q1

Datasheet of LMP7721MAX/NOPB - IC OPAMP GP 17MHZ RRO 8SOIC Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



PACKAGE MATERIALS INFORMATION

www.ti.com 21-Oct-2014



*All dimensions are nominal

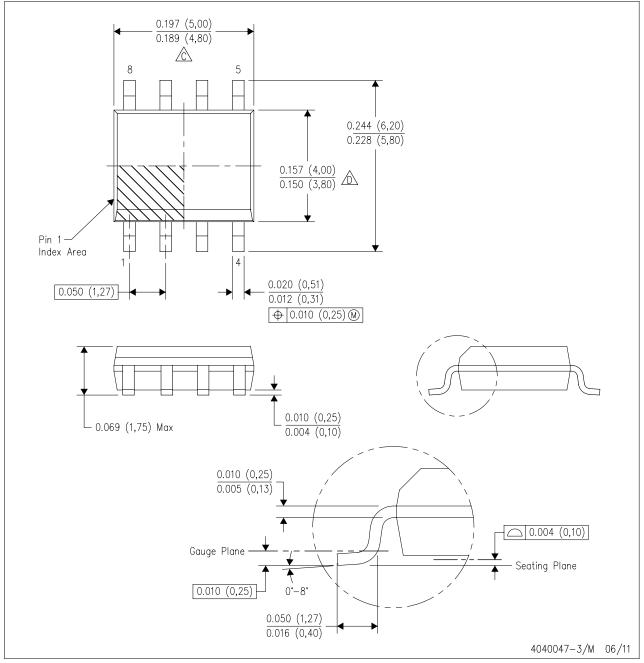
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LMP7721MAX/NOPB	SOIC	D	8	2500	367.0	367.0	35.0



MECHANICAL DATA

D (R-PDSO-G8)

PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AA.





Distributor of Texas Instruments: Excellent Integrated System LimitedDatasheet of LMP7721MAX/NOPB - IC OPAMP GP 17MHZ RRO 8SOIC

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All semiconductor products (also referred to herein as "components") are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its components to the specifications applicable at the time of sale, in accordance with the warranty in TI's terms and conditions of sale of semiconductor products. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by applicable law, testing of all parameters of each component is not necessarily performed.

TI assumes no liability for applications assistance or the design of Buyers' products. Buyers are responsible for their products and applications using TI components. To minimize the risks associated with Buyers' products and applications, Buyers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI components or services are used. Information published by TI regarding third-party products or services does not constitute a license to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of significant portions of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI components or services with statements different from or beyond the parameters stated by TI for that component or service voids all express and any implied warranties for the associated TI component or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Buyer acknowledges and agrees that it is solely responsible for compliance with all legal, regulatory and safety-related requirements concerning its products, and any use of TI components in its applications, notwithstanding any applications-related information or support that may be provided by TI. Buyer represents and agrees that it has all the necessary expertise to create and implement safeguards which anticipate dangerous consequences of failures, monitor failures and their consequences, lessen the likelihood of failures that might cause harm and take appropriate remedial actions. Buyer will fully indemnify TI and its representatives against any damages arising out of the use of any TI components in safety-critical applications.

In some cases, TI components may be promoted specifically to facilitate safety-related applications. With such components, TI's goal is to help enable customers to design and create their own end-product solutions that meet applicable functional safety standards and requirements. Nonetheless, such components are subject to these terms.

No TI components are authorized for use in FDA Class III (or similar life-critical medical equipment) unless authorized officers of the parties have executed a special agreement specifically governing such use.

Only those TI components which TI has specifically designated as military grade or "enhanced plastic" are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components which have *not* been so designated is solely at the Buyer's risk, and that Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI has specifically designated certain components as meeting ISO/TS16949 requirements, mainly for automotive use. In any case of use of non-designated products, TI will not be responsible for any failure to meet ISO/TS16949.

Products Applications

www.ti.com/audio Audio Automotive and Transportation www.ti.com/automotive Amplifiers amplifier.ti.com Communications and Telecom www.ti.com/communications Computers and Peripherals www.ti.com/computers **Data Converters** dataconverter.ti.com **DLP® Products** www.dlp.com Consumer Electronics www.ti.com/consumer-apps DSP dsp.ti.com **Energy and Lighting** www.ti.com/energy Clocks and Timers www.ti.com/clocks Industrial www.ti.com/industrial

 Interface
 interface.ti.com
 Medical
 www.ti.com/medical

 Logic
 logic.ti.com
 Security
 www.ti.com/security

Power Mgmt Space, Avionics and Defense <u>www.ti.com/space-avionics-defense</u>

Microcontrollers microcontroller.ti.com Video and Imaging www.ti.com/video

RFID <u>www.ti-rfid.com</u>

OMAP Applications Processors www.ti.com/omap TI E2E Community e2e.ti.com

Wireless Connectivity www.ti.com/wirelessconnectivity

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2014, Texas Instruments Incorporated